## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Kie Y. Ahn et al.

MULTILEVEL COPPER INTER SONNECTS WITH LOW-K DIELECTRICS AND AIR

GAPS

Docket No · 303 686US3

Title:

Filed: February 25, 2004 Examiner:

Andy Huynh

Serial No.: 10/786,354 Due Date: January 15, 2005

Group Art Unit: 2818

Mail Stop Amendment

Commissioner for Patents P.O. Box 1450

Alexandria, VA 22313-1450

We are transmitting herewith the following attached items (as indicated with an "X"):

A return postcard.

Amendment and Response Under 37 CFR 1.111 (8 Pages).

Copy of pages 4 and 7 of Form 1449 originally submitted on February 25, 2004 (2 pgs.).

If not provided for in a separate paper filed herewith, Please consider this a PETITION FOR EXTENSION OF TIME for sufficient number of months to enter these papers and please charge any additional fees or credit overpayment to Deposit Account No. 19-0743.

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.

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CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: Mail Stop Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on this \_\_\_\_ day of January, 2005.

Kacia Lee

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.

(GENERAL)

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SS 10/786,354 PATENT
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Examiner: Andy Huynh

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Title: MULTILEVEL

MULTILEVEL COPPER INTERCONNECTS WITH LOW-K DIELECTRICS

AND AIR GAPS

## **AMENDMENT AND RESPONSE UNDER 37 CFR § 1.111**

MS Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

This paper responds to the Office Action mailed on October 15, 2004. Please amend the above-identified patent application as follows.